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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

| | |
|--------------------------------|---|
| Product Status | Active |
| Number of LABs/CLBs | 11519 |
| Number of Logic Elements/Cells | 147443 |
| Total RAM Bits | 4939776 |
| Number of I/O | 338 |
| Number of Gates | - |
| Voltage - Supply | 1.14V ~ 1.26V |
| Mounting Type | Surface Mount |
| Operating Temperature | 0°C ~ 85°C (TJ) |
| Package / Case | 484-BBGA |
| Supplier Device Package | 484-FBGA (23x23) |
| Purchase URL | https://www.e-xfl.com/product-detail/xilinx/xc6slx150-n3fgg484c |

Table 8: Recommended Operating Conditions for User I/Os Using Differential Signal Standards

| I/O Standard | V _{CCO} for Drivers | | |
|--------------------------|------------------------------|--------|--------|
| | V, Min | V, Nom | V, Max |
| LVDS_33 | 3.0 | 3.3 | 3.45 |
| LVDS_25 | 2.25 | 2.5 | 2.75 |
| BLVDS_25 | 2.25 | 2.5 | 2.75 |
| MINI_LVDS_33 | 3.0 | 3.3 | 3.45 |
| MINI_LVDS_25 | 2.25 | 2.5 | 2.75 |
| LVPECL_33 ⁽¹⁾ | N/A—Inputs Only | | |
| LVPECL_25 | N/A—Inputs Only | | |
| RSDS_33 | 3.0 | 3.3 | 3.45 |
| RSDS_25 | 2.25 | 2.5 | 2.75 |
| TMDS_33 ⁽¹⁾ | 3.14 | 3.3 | 3.45 |
| PPDS_33 | 3.0 | 3.3 | 3.45 |
| PPDS_25 | 2.25 | 2.5 | 2.75 |
| DISPLAY_PORT | 2.3 | 2.5 | 2.7 |
| DIFF_MOBILE_DDR | 1.7 | 1.8 | 1.9 |
| DIFF_HSTL_I | 1.4 | 1.5 | 1.6 |
| DIFF_HSTL_II | 1.4 | 1.5 | 1.6 |
| DIFF_HSTL_III | 1.4 | 1.5 | 1.6 |
| DIFF_HSTL_I_18 | 1.7 | 1.8 | 1.9 |
| DIFF_HSTL_II_18 | 1.7 | 1.8 | 1.9 |
| DIFF_HSTL_III_18 | 1.7 | 1.8 | 1.9 |
| DIFF_SSTL3_I | 3.0 | 3.3 | 3.45 |
| DIFF_SSTL3_II | 3.0 | 3.3 | 3.45 |
| DIFF_SSTL2_I | 2.3 | 2.5 | 2.7 |
| DIFF_SSTL2_II | 2.3 | 2.5 | 2.7 |
| DIFF_SSTL18_I | 1.7 | 1.8 | 1.9 |
| DIFF_SSTL18_II | 1.7 | 1.8 | 1.9 |
| DIFF_SSTL15_II | 1.425 | 1.5 | 1.575 |

Notes:

1. LVPECL_33 and TMDS_33 inputs require V_{CCAUX} = 3.3V nominal.

GTP Transceiver DC Input and Output Levels

Table 16 summarizes the DC output specifications of the GTP transceivers in Spartan-6 FPGAs. Figure 1 shows the single-ended output voltage swing. Figure 2 shows the peak-to-peak differential output voltage.

Consult [UG386: Spartan-6 FPGA GTP Transceivers User Guide](#) for further details.

Table 16: GTP Transceiver DC Specifications

| Symbol | DC Parameter | Conditions | Min | Typ | Max | Units |
|----------------------|---|--|----------------------------------|------------------|-----------|-------|
| DV _{PPIN} | Differential peak-to-peak input voltage | External AC coupled | 140 | — | 2000 | mV |
| V _{IN} | Absolute input voltage | DC coupled MGTAVTTRX = 1.2V | -400 | — | MGTAVTTRX | mV |
| V _{CMIN} | Common mode input voltage | DC coupled MGTAVTTRX = 1.2V | — | 3/4 MGTAVTTRX | — | mV |
| DV _{PPOUT} | Differential peak-to-peak output voltage ⁽¹⁾ | Transmitter output swing is set to maximum setting | — | — | 1000 | mV |
| V _{SEOUT} | Single-ended output voltage ⁽¹⁾ | — | — | — | 500 | mV |
| V _{CMOUTDC} | Common mode output voltage | Equation based | MGTAVTTX - V _{SEOUT} /2 | | | mV |
| R _{IN} | Differential input resistance | — | 80 | 100 | 130 | Ω |
| R _{OUT} | Differential output resistance | — | 80 | 100 | 130 | Ω |
| T _{OSKEW} | Transmitter output skew | — | — | — | 15 | ps |
| C _{EXT} | Recommended external AC coupling capacitor ⁽²⁾ | — | 75 | 100 | 200 | nF |

Notes:

1. The output swing and preemphasis levels are programmable using the attributes discussed in [UG386: Spartan-6 FPGA GTP Transceivers User Guide](#) and can result in values lower than reported in this table.
2. Other values can be used as appropriate to conform to specific protocols and standards.

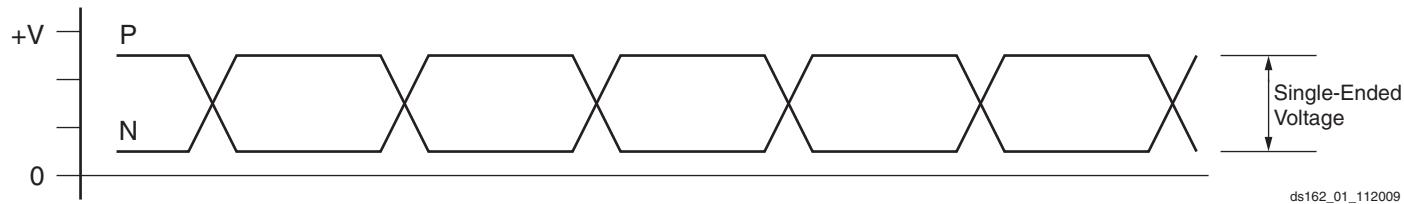


Figure 1: Single-Ended Peak-to-Peak Voltage

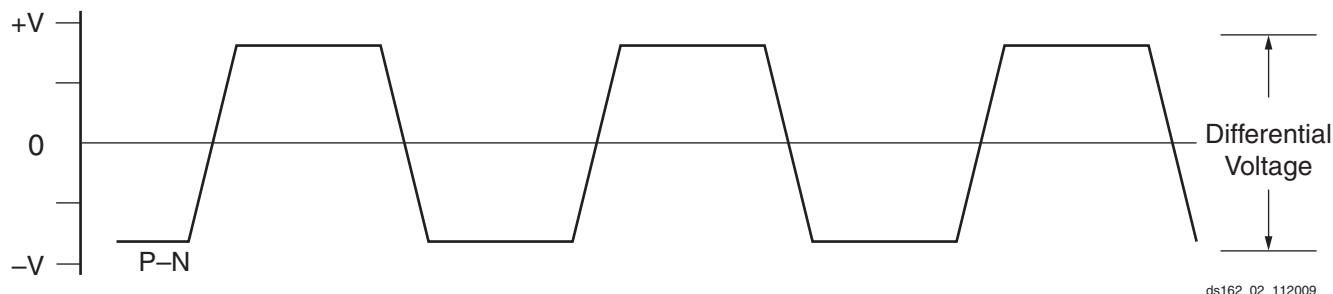


Figure 2: Differential Peak-to-Peak Voltage

Table 17 summarizes the DC specifications of the clock input of the GTP transceiver. Consult [UG386: Spartan-6 FPGA GTP Transceivers User Guide](#) for further details.

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

| I/O Standard | T _{IOPI} | | | | T _{IOOP} | | | | T _{IOTP} | | | | Units | |
|--------------------------|-------------------|------|------|--------------------|-------------------|------|------|--------------------|-------------------|------|------|--------------------|-------|--|
| | Speed Grade | | | | Speed Grade | | | | Speed Grade | | | | | |
| | -3 | -3N | -2 | -1L ⁽¹⁾ | -3 | -3N | -2 | -1L ⁽¹⁾ | -3 | -3N | -2 | -1L ⁽¹⁾ | | |
| LVCMOS33, Fast, 8 mA | 1.34 | 1.46 | 1.59 | 1.82 | 2.07 | 2.21 | 2.41 | 3.03 | 2.07 | 2.21 | 2.41 | 3.03 | ns | |
| LVCMOS33, Fast, 12 mA | 1.34 | 1.46 | 1.59 | 1.82 | 1.65 | 1.79 | 1.99 | 2.62 | 1.65 | 1.79 | 1.99 | 2.62 | ns | |
| LVCMOS33, Fast, 16 mA | 1.34 | 1.46 | 1.59 | 1.82 | 1.65 | 1.79 | 1.99 | 2.62 | 1.65 | 1.79 | 1.99 | 2.62 | ns | |
| LVCMOS33, Fast, 24 mA | 1.34 | 1.46 | 1.59 | 1.82 | 1.65 | 1.79 | 1.99 | 2.62 | 1.65 | 1.79 | 1.99 | 2.62 | ns | |
| LVCMOS25, QUIETIO, 2 mA | 0.82 | 0.94 | 1.07 | 1.31 | 4.81 | 4.95 | 5.15 | 5.79 | 4.81 | 4.95 | 5.15 | 5.79 | ns | |
| LVCMOS25, QUIETIO, 4 mA | 0.82 | 0.94 | 1.07 | 1.31 | 3.70 | 3.84 | 4.04 | 4.66 | 3.70 | 3.84 | 4.04 | 4.66 | ns | |
| LVCMOS25, QUIETIO, 6 mA | 0.82 | 0.94 | 1.07 | 1.31 | 3.46 | 3.60 | 3.80 | 4.38 | 3.46 | 3.60 | 3.80 | 4.38 | ns | |
| LVCMOS25, QUIETIO, 8 mA | 0.82 | 0.94 | 1.07 | 1.31 | 3.20 | 3.34 | 3.54 | 4.12 | 3.20 | 3.34 | 3.54 | 4.12 | ns | |
| LVCMOS25, QUIETIO, 12 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.83 | 2.97 | 3.17 | 3.75 | 2.83 | 2.97 | 3.17 | 3.75 | ns | |
| LVCMOS25, QUIETIO, 16 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.64 | 2.78 | 2.98 | 3.64 | 2.64 | 2.78 | 2.98 | 3.64 | ns | |
| LVCMOS25, QUIETIO, 24 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.45 | 2.59 | 2.79 | 3.42 | 2.45 | 2.59 | 2.79 | 3.42 | ns | |
| LVCMOS25, Slow, 2 mA | 0.82 | 0.94 | 1.07 | 1.31 | 3.78 | 3.92 | 4.12 | 4.76 | 3.78 | 3.92 | 4.12 | 4.76 | ns | |
| LVCMOS25, Slow, 4 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.79 | 2.93 | 3.13 | 3.73 | 2.79 | 2.93 | 3.13 | 3.73 | ns | |
| LVCMOS25, Slow, 6 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.73 | 2.87 | 3.07 | 3.66 | 2.73 | 2.87 | 3.07 | 3.66 | ns | |
| LVCMOS25, Slow, 8 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.48 | 2.62 | 2.82 | 3.42 | 2.48 | 2.62 | 2.82 | 3.42 | ns | |
| LVCMOS25, Slow, 12 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.01 | 2.15 | 2.35 | 2.95 | 2.01 | 2.15 | 2.35 | 2.95 | ns | |
| LVCMOS25, Slow, 16 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.01 | 2.15 | 2.35 | 2.95 | 2.01 | 2.15 | 2.35 | 2.95 | ns | |
| LVCMOS25, Slow, 24 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.01 | 2.15 | 2.35 | 2.94 | 2.01 | 2.15 | 2.35 | 2.94 | ns | |
| LVCMOS25, Fast, 2 mA | 0.82 | 0.94 | 1.07 | 1.31 | 3.35 | 3.49 | 3.69 | 4.31 | 3.35 | 3.49 | 3.69 | 4.31 | ns | |
| LVCMOS25, Fast, 4 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.25 | 2.39 | 2.59 | 3.22 | 2.25 | 2.39 | 2.59 | 3.22 | ns | |
| LVCMOS25, Fast, 6 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.09 | 2.23 | 2.43 | 3.05 | 2.09 | 2.23 | 2.43 | 3.05 | ns | |
| LVCMOS25, Fast, 8 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.02 | 2.16 | 2.36 | 2.98 | 2.02 | 2.16 | 2.36 | 2.98 | ns | |
| LVCMOS25, Fast, 12 mA | 0.82 | 0.94 | 1.07 | 1.31 | 1.56 | 1.70 | 1.90 | 2.52 | 1.56 | 1.70 | 1.90 | 2.52 | ns | |
| LVCMOS25, Fast, 16 mA | 0.82 | 0.94 | 1.07 | 1.31 | 1.56 | 1.70 | 1.90 | 2.52 | 1.56 | 1.70 | 1.90 | 2.52 | ns | |
| LVCMOS25, Fast, 24 mA | 0.82 | 0.94 | 1.07 | 1.31 | 1.56 | 1.70 | 1.90 | 2.52 | 1.56 | 1.70 | 1.90 | 2.52 | ns | |
| LVCMOS18, QUIETIO, 2 mA | 1.18 | 1.30 | 1.43 | 2.04 | 5.92 | 6.06 | 6.26 | 6.80 | 5.92 | 6.06 | 6.26 | 6.80 | ns | |
| LVCMOS18, QUIETIO, 4 mA | 1.18 | 1.30 | 1.43 | 2.04 | 4.74 | 4.88 | 5.08 | 5.63 | 4.74 | 4.88 | 5.08 | 5.63 | ns | |
| LVCMOS18, QUIETIO, 6 mA | 1.18 | 1.30 | 1.43 | 2.04 | 4.05 | 4.19 | 4.39 | 4.96 | 4.05 | 4.19 | 4.39 | 4.96 | ns | |
| LVCMOS18, QUIETIO, 8 mA | 1.18 | 1.30 | 1.43 | 2.04 | 3.71 | 3.85 | 4.05 | 4.63 | 3.71 | 3.85 | 4.05 | 4.63 | ns | |
| LVCMOS18, QUIETIO, 12 mA | 1.18 | 1.30 | 1.43 | 2.04 | 3.35 | 3.49 | 3.69 | 4.27 | 3.35 | 3.49 | 3.69 | 4.27 | ns | |
| LVCMOS18, QUIETIO, 16 mA | 1.18 | 1.30 | 1.43 | 2.04 | 3.20 | 3.34 | 3.54 | 4.14 | 3.20 | 3.34 | 3.54 | 4.14 | ns | |
| LVCMOS18, QUIETIO, 24 mA | 1.18 | 1.30 | 1.43 | 2.04 | 2.96 | 3.10 | 3.30 | 3.98 | 2.96 | 3.10 | 3.30 | 3.98 | ns | |
| LVCMOS18, Slow, 2 mA | 1.18 | 1.30 | 1.43 | 2.04 | 4.62 | 4.76 | 4.96 | 5.54 | 4.62 | 4.76 | 4.96 | 5.54 | ns | |
| LVCMOS18, Slow, 4 mA | 1.18 | 1.30 | 1.43 | 2.04 | 3.69 | 3.83 | 4.03 | 4.60 | 3.69 | 3.83 | 4.03 | 4.60 | ns | |
| LVCMOS18, Slow, 6 mA | 1.18 | 1.30 | 1.43 | 2.04 | 3.00 | 3.14 | 3.34 | 3.94 | 3.00 | 3.14 | 3.34 | 3.94 | ns | |
| LVCMOS18, Slow, 8 mA | 1.18 | 1.30 | 1.43 | 2.04 | 2.19 | 2.33 | 2.53 | 3.17 | 2.19 | 2.33 | 2.53 | 3.17 | ns | |
| LVCMOS18, Slow, 12 mA | 1.18 | 1.30 | 1.43 | 2.04 | 1.99 | 2.13 | 2.33 | 2.95 | 1.99 | 2.13 | 2.33 | 2.95 | ns | |
| LVCMOS18, Slow, 16 mA | 1.18 | 1.30 | 1.43 | 2.04 | 1.99 | 2.13 | 2.33 | 2.95 | 1.99 | 2.13 | 2.33 | 2.95 | ns | |

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices⁽¹⁾

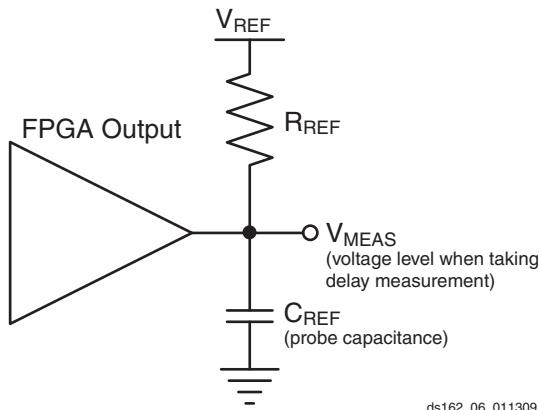
| I/O Standard | T _{IOPI} | | T _{IOOP} | | T _{IOTP} | | Units | |
|--------------------------|-------------------|------|-------------------|-------|-------------------|-------|-------|--|
| | Speed Grade | | Speed Grade | | Speed Grade | | | |
| | -3 | -2 | -3 | -2 | -3 | -2 | | |
| LVDS_33 | 1.24 | 1.42 | 1.69 | 1.89 | 3000 | 3000 | ns | |
| LVDS_25 | 1.08 | 1.26 | 1.79 | 1.99 | 3000 | 3000 | ns | |
| BLVDS_25 | 1.09 | 1.27 | 1.86 | 2.06 | 1.86 | 2.06 | ns | |
| MINI_LVDS_33 | 1.25 | 1.43 | 1.71 | 1.91 | 3000 | 3000 | ns | |
| MINI_LVDS_25 | 1.08 | 1.26 | 1.79 | 1.99 | 3000 | 3000 | ns | |
| LVPECL_33 | 1.25 | 1.43 | N/A | N/A | N/A | N/A | ns | |
| LVPECL_25 | 1.09 | 1.27 | N/A | N/A | N/A | N/A | ns | |
| RSDS_33 (point to point) | 1.24 | 1.42 | 1.71 | 1.91 | 3000 | 3000 | ns | |
| RSDS_25 (point to point) | 1.08 | 1.26 | 1.79 | 1.99 | 3000 | 3000 | ns | |
| TMDS_33 | 1.29 | 1.47 | 1.68 | 1.88 | 3000 | 3000 | ns | |
| PPDS_33 | 1.25 | 1.43 | 1.71 | 1.91 | 3000 | 3000 | ns | |
| PPDS_25 | 1.08 | 1.26 | 1.82 | 2.02 | 3000 | 3000 | ns | |
| PCI33_3 | 1.14 | 1.32 | 3.81 | 4.01 | 3.81 | 4.01 | ns | |
| PCI66_3 | 1.14 | 1.32 | 3.81 | 4.01 | 3.81 | 4.01 | ns | |
| DISPLAY_PORT | 1.09 | 1.27 | 3.29 | 3.49 | 3.29 | 3.49 | ns | |
| I2C | 1.40 | 1.58 | 11.70 | 11.90 | 11.70 | 11.90 | ns | |
| SMBUS | 1.40 | 1.58 | 11.70 | 11.90 | 11.70 | 11.90 | ns | |
| SDIO | 1.43 | 1.61 | 2.78 | 2.98 | 2.78 | 2.98 | ns | |
| MOBILE_DDR | 1.01 | 1.19 | 2.50 | 2.70 | 2.50 | 2.70 | ns | |
| HSTL_I | 1.01 | 1.19 | 1.80 | 2.00 | 1.80 | 2.00 | ns | |
| HSTL_II | 1.01 | 1.19 | 1.86 | 2.06 | 1.86 | 2.06 | ns | |
| HSTL_III | 1.07 | 1.25 | 1.81 | 2.01 | 1.81 | 2.01 | ns | |
| HSTL_I_18 | 1.05 | 1.23 | 1.91 | 2.11 | 1.91 | 2.11 | ns | |
| HSTL_II_18 | 1.05 | 1.23 | 1.99 | 2.19 | 1.99 | 2.19 | ns | |
| HSTL_III_18 | 1.13 | 1.31 | 1.93 | 2.13 | 1.93 | 2.13 | ns | |
| SSTL3_I | 1.65 | 1.83 | 1.97 | 2.17 | 1.97 | 2.17 | ns | |
| SSTL3_II | 1.65 | 1.83 | 2.15 | 2.35 | 2.15 | 2.35 | ns | |
| SSTL2_I | 1.37 | 1.55 | 1.91 | 2.11 | 1.91 | 2.11 | ns | |
| SSTL2_II | 1.37 | 1.55 | 2.00 | 2.20 | 2.00 | 2.20 | ns | |
| SSTL18_I | 0.99 | 1.17 | 1.77 | 1.97 | 1.77 | 1.97 | ns | |
| SSTL18_II | 1.00 | 1.18 | 1.80 | 2.00 | 1.80 | 2.00 | ns | |
| SSTL15_II | 1.00 | 1.18 | 1.81 | 2.01 | 1.81 | 2.01 | ns | |
| DIFF_HSTL_I | 1.01 | 1.19 | 1.91 | 2.11 | 1.91 | 2.11 | ns | |
| DIFF_HSTL_II | 1.00 | 1.18 | 1.86 | 2.06 | 1.86 | 2.06 | ns | |
| DIFF_HSTL_III | 1.00 | 1.18 | 1.83 | 2.03 | 1.83 | 2.03 | ns | |
| DIFF_HSTL_I_18 | 1.04 | 1.22 | 1.93 | 2.13 | 1.93 | 2.13 | ns | |
| DIFF_HSTL_II_18 | 1.04 | 1.22 | 1.83 | 2.03 | 1.83 | 2.03 | ns | |
| DIFF_HSTL_III_18 | 1.04 | 1.22 | 1.83 | 2.03 | 1.83 | 2.03 | ns | |

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices⁽¹⁾ (Cont'd)

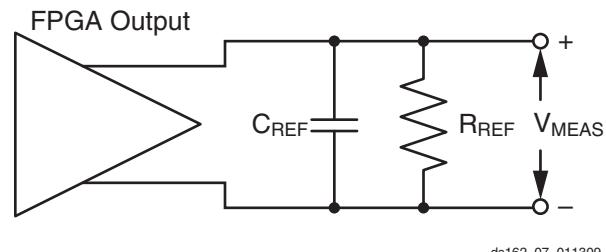
| I/O Standard | T _{IOP1} | | T _{IOOP} | | T _{IOTP} | | Units | |
|--------------------------|-------------------|------|-------------------|------|-------------------|------|-------|--|
| | Speed Grade | | Speed Grade | | Speed Grade | | | |
| | -3 | -2 | -3 | -2 | -3 | -2 | | |
| LVCMOS33, Slow, 6 mA | 1.41 | 1.59 | 2.79 | 2.99 | 2.79 | 2.99 | ns | |
| LVCMOS33, Slow, 8 mA | 1.41 | 1.59 | 2.79 | 2.99 | 2.79 | 2.99 | ns | |
| LVCMOS33, Slow, 12 mA | 1.41 | 1.59 | 2.53 | 2.73 | 2.53 | 2.73 | ns | |
| LVCMOS33, Slow, 16 mA | 1.41 | 1.59 | 2.45 | 2.65 | 2.45 | 2.65 | ns | |
| LVCMOS33, Slow, 24 mA | 1.41 | 1.59 | 2.42 | 2.62 | 2.42 | 2.62 | ns | |
| LVCMOS33, Fast, 2 mA | 1.41 | 1.59 | 4.05 | 4.25 | 4.05 | 4.25 | ns | |
| LVCMOS33, Fast, 4 mA | 1.41 | 1.59 | 2.66 | 2.86 | 2.66 | 2.86 | ns | |
| LVCMOS33, Fast, 6 mA | 1.41 | 1.59 | 2.46 | 2.66 | 2.46 | 2.66 | ns | |
| LVCMOS33, Fast, 8 mA | 1.41 | 1.59 | 2.21 | 2.41 | 2.21 | 2.41 | ns | |
| LVCMOS33, Fast, 12 mA | 1.41 | 1.59 | 1.80 | 2.00 | 1.80 | 2.00 | ns | |
| LVCMOS33, Fast, 16 mA | 1.41 | 1.59 | 1.80 | 2.00 | 1.80 | 2.00 | ns | |
| LVCMOS33, Fast, 24 mA | 1.41 | 1.59 | 1.80 | 2.00 | 1.80 | 2.00 | ns | |
| LVCMOS25, QUIETIO, 2 mA | 0.89 | 1.07 | 5.00 | 5.20 | 5.00 | 5.20 | ns | |
| LVCMOS25, QUIETIO, 4 mA | 0.89 | 1.07 | 3.85 | 4.05 | 3.85 | 4.05 | ns | |
| LVCMOS25, QUIETIO, 6 mA | 0.89 | 1.07 | 3.60 | 3.80 | 3.60 | 3.80 | ns | |
| LVCMOS25, QUIETIO, 8 mA | 0.89 | 1.07 | 3.34 | 3.54 | 3.34 | 3.54 | ns | |
| LVCMOS25, QUIETIO, 12 mA | 0.89 | 1.07 | 2.98 | 3.18 | 2.98 | 3.18 | ns | |
| LVCMOS25, QUIETIO, 16 mA | 0.89 | 1.07 | 2.79 | 2.99 | 2.79 | 2.99 | ns | |
| LVCMOS25, QUIETIO, 24 mA | 0.89 | 1.07 | 2.64 | 2.84 | 2.64 | 2.84 | ns | |
| LVCMOS25, Slow, 2 mA | 0.89 | 1.07 | 3.96 | 4.16 | 3.96 | 4.16 | ns | |
| LVCMOS25, Slow, 4 mA | 0.89 | 1.07 | 2.96 | 3.16 | 2.96 | 3.16 | ns | |
| LVCMOS25, Slow, 6 mA | 0.89 | 1.07 | 2.88 | 3.08 | 2.88 | 3.08 | ns | |
| LVCMOS25, Slow, 8 mA | 0.89 | 1.07 | 2.63 | 2.83 | 2.63 | 2.83 | ns | |
| LVCMOS25, Slow, 12 mA | 0.89 | 1.07 | 2.15 | 2.35 | 2.15 | 2.35 | ns | |
| LVCMOS25, Slow, 16 mA | 0.89 | 1.07 | 2.15 | 2.35 | 2.15 | 2.35 | ns | |
| LVCMOS25, Slow, 24 mA | 0.89 | 1.07 | 2.15 | 2.35 | 2.15 | 2.35 | ns | |
| LVCMOS25, Fast, 2 mA | 0.89 | 1.07 | 3.52 | 3.72 | 3.52 | 3.72 | ns | |
| LVCMOS25, Fast, 4 mA | 0.89 | 1.07 | 2.43 | 2.63 | 2.43 | 2.63 | ns | |
| LVCMOS25, Fast, 6 mA | 0.89 | 1.07 | 2.23 | 2.43 | 2.23 | 2.43 | ns | |
| LVCMOS25, Fast, 8 mA | 0.89 | 1.07 | 2.16 | 2.36 | 2.16 | 2.36 | ns | |
| LVCMOS25, Fast, 12 mA | 0.89 | 1.07 | 1.70 | 1.90 | 1.70 | 1.90 | ns | |
| LVCMOS25, Fast, 16 mA | 0.89 | 1.07 | 1.70 | 1.90 | 1.70 | 1.90 | ns | |
| LVCMOS25, Fast, 24 mA | 0.89 | 1.07 | 1.70 | 1.90 | 1.70 | 1.90 | ns | |
| LVCMOS18, QUIETIO, 2 mA | 1.25 | 1.43 | 6.11 | 6.31 | 6.11 | 6.31 | ns | |
| LVCMOS18, QUIETIO, 4 mA | 1.25 | 1.43 | 4.88 | 5.08 | 4.88 | 5.08 | ns | |
| LVCMOS18, QUIETIO, 6 mA | 1.25 | 1.43 | 4.20 | 4.40 | 4.20 | 4.40 | ns | |
| LVCMOS18, QUIETIO, 8 mA | 1.25 | 1.43 | 3.86 | 4.06 | 3.86 | 4.06 | ns | |
| LVCMOS18, QUIETIO, 12 mA | 1.25 | 1.43 | 3.49 | 3.69 | 3.49 | 3.69 | ns | |

Output Delay Measurements

Output delays are measured using a Tektronix P6245 TDS500/600 probe (<1 pF) across approximately 4" of FR4 microstrip trace. Standard termination was used for all testing. The propagation delay of the 4" trace is characterized separately and subtracted from the final measurement, and is therefore not included in the generalized test setups shown in [Figure 4](#) and [Figure 5](#).



[Figure 4: Single-Ended Test Setup](#)



[Figure 5: Differential Test Setup](#)

Measurements and test conditions are reflected in the IBIS models except where the IBIS format precludes it. Parameters V_{REF} , R_{REF} , C_{REF} , and V_{MEAS} fully describe the test conditions for each I/O standard. The most accurate prediction of propagation delay in any given application can be obtained through IBIS simulation, using the following method:

1. Simulate the output driver of choice into the generalized test setup, using values from [Table 32](#).
2. Record the time to V_{MEAS} .
3. Simulate the output driver of choice into the actual PCB trace and load, using the appropriate IBIS model or capacitance value to represent the load.
4. Record the time to V_{MEAS} .
5. Compare the results of steps 2 and 4. The increase or decrease in delay yields the actual propagation delay of the PCB trace.

[Table 32: Output Delay Measurement Methodology](#)

| Description | I/O Standard Attribute | R_{REF} (Ω) | C_{REF} ⁽¹⁾ (pF) | V_{MEAS} (V) | V_{REF} (V) |
|---|---------------------------------|------------------------|-----------------------------------|----------------|---------------|
| LVTTL (Low-Voltage Transistor-Transistor Logic) | LVTTL (all) | 1M | 0 | 1.4 | 0 |
| LVCMOS (Low-Voltage CMOS), 3.3V | LVCMOS33 | 1M | 0 | 1.65 | 0 |
| LVCMOS, 2.5V | LVCMOS25 | 1M | 0 | 1.25 | 0 |
| LVCMOS, 1.8V | LVCMOS18 | 1M | 0 | 0.9 | 0 |
| LVCMOS, 1.5V | LVCMOS15 | 1M | 0 | 0.75 | 0 |
| LVCMOS, 1.2V | LVCMOS12 | 1M | 0 | 0.6 | 0 |
| PCI (Peripheral Component Interface) 33 MHz and 66 MHz, 3.3V | PCI33_3, PCI66_3 (rising edge) | 25 | 10 ⁽²⁾ | 0.94 | 0 |
| | PCI33_3, PCI66_3 (falling edge) | 25 | 10 ⁽²⁾ | 2.03 | 3.3 |
| HSTL (High-Speed Transceiver Logic), Class I | HSTL_I | 50 | 0 | V_{REF} | 0.75 |
| HSTL, Class II | HSTL_II | 25 | 0 | V_{REF} | 0.75 |
| HSTL, Class III | HSTL_III | 50 | 0 | 0.9 | 1.5 |
| HSTL, Class I, 1.8V | HSTL_I_18 | 50 | 0 | V_{REF} | 0.9 |
| HSTL, Class II, 1.8V | HSTL_II_18 | 25 | 0 | V_{REF} | 0.9 |
| HSTL, Class III, 1.8V | HSTL_III_18 | 50 | 0 | 1.1 | 1.8 |
| SSTL (Stub Series Terminated Logic), Class I, 1.8V | SSTL18_I | 50 | 0 | V_{REF} | 0.9 |
| SSTL, Class II, 1.8V | SSTL18_II | 25 | 0 | V_{REF} | 0.9 |
| SSTL, Class I, 2.5V | SSTL2_I | 50 | 0 | V_{REF} | 1.25 |

Table 33: Spartan-6 FPGA V_{CCO}/GND Pairs per Bank

| Package | Devices | Description | Bank 0 | Bank 1 | Bank 2 | Bank 3 | Bank 4 | Bank 5 |
|----------|--------------------|-----------------------------|--------|--------|--------|--------|--------|--------|
| TQG144 | LX | V _{CCO} /GND Pairs | 3 | 3 | 2 | 3 | N/A | N/A |
| | | Maximum I/O per Pair | 8 | 8 | 13 | 8 | N/A | N/A |
| CPG196 | LX | V _{CCO} /GND Pairs | 4 | 6 | 4 | 6 | N/A | N/A |
| | | Maximum I/O per Pair | 6 | 4 | 7 | 4 | N/A | N/A |
| CSG225 | LX | V _{CCO} /GND Pairs | 4 | 4 | 4 | 4 | N/A | N/A |
| | | Maximum I/O per Pair | 10 | 10 | 9 | 10 | N/A | N/A |
| FT(G)256 | LX | V _{CCO} /GND Pairs | 5 | 6 | 4 | 5 | N/A | N/A |
| | | Maximum I/O per Pair | 8 | 9 | 9 | 10 | N/A | N/A |
| CSG324 | LX | V _{CCO} /GND Pairs | 6 | 6 | 6 | 6 | N/A | N/A |
| | | Maximum I/O per Pair | 10 | 9 | 10 | 9 | N/A | N/A |
| | LXT | V _{CCO} /GND Pairs | 4 | 6 | 6 | 6 | N/A | N/A |
| | | Maximum I/O per Pair | 4 | 9 | 10 | 9 | N/A | N/A |
| CS(G)484 | LX | V _{CCO} /GND Pairs | 8 | 13 | 8 | 13 | N/A | N/A |
| | | Maximum I/O per Pair | 7 | 8 | 7 | 8 | N/A | N/A |
| | LXT | V _{CCO} /GND Pairs | 7 | 12 | 8 | 13 | N/A | N/A |
| | | Maximum I/O per Pair | 5 | 8 | 6 | 8 | N/A | N/A |
| FG(G)484 | LX | V _{CCO} /GND Pairs | 10 | 10 | 11 | 11 | N/A | N/A |
| | | Maximum I/O per Pair | 6 | 8 | 9 | 8 | N/A | N/A |
| | LXT | V _{CCO} /GND Pairs | 6 | 10 | 11 | 10 | N/A | N/A |
| | | Maximum I/O per Pair | 7 | 8 | 7 | 8 | N/A | N/A |
| FG(G)676 | LX45 | V _{CCO} /GND Pairs | 12 | 15 | 10 | 16 | N/A | N/A |
| | | Maximum I/O per Pair | 3 | 7 | 8 | 7 | N/A | N/A |
| | LX75, LX100, LX150 | V _{CCO} /GND Pairs | 12 | 9 | 10 | 10 | 6 | 6 |
| | | Maximum I/O per Pair | 9 | 10 | 9 | 9 | 8 | 9 |
| FG(G)900 | LXT | V _{CCO} /GND Pairs | 10 | 8 | 10 | 8 | 7 | 7 |
| | | Maximum I/O per Pair | 8 | 7 | 8 | 8 | 7 | 7 |
| | LX | V _{CCO} /GND Pairs | 17 | 14 | 17 | 14 | 7 | 8 |
| | | Maximum I/O per Pair | 7 | 6 | 7 | 8 | 7 | 6 |
| | LXT | V _{CCO} /GND Pairs | 15 | 14 | 13 | 14 | 7 | 8 |
| | | Maximum I/O per Pair | 7 | 6 | 8 | 8 | 7 | 6 |

Input Serializer/Deserializer Switching Characteristics

Table 37: ISERDES2 Switching Characteristics

| Symbol | Description | Speed Grade | | | | Units |
|---|---|----------------|----------------|----------------|----------------|-------|
| | | -3 | -3N | -2 | -1L | |
| Setup/Hold for Control Lines | | | | | | |
| T _{ISCKC_BITSLIP} / T _{ISCKC_BITSLIP} | BITSLIP pin Setup/Hold with respect to CLKDIV | 0.16/ -0.09 | 0.20/ -0.09 | 0.31/ -0.09 | 0.34/ -0.14 | ns |
| T _{ISCKC_CE} / T _{ISCKC_CE} | CE pin Setup/Hold with respect to CLK | 0.71/ -0.47 | 0.71/ -0.42 | 0.97/ -0.42 | 1.39/ -0.71 | ns |
| Setup/Hold for Data Lines | | | | | | |
| T _{ISDCK_D} / T _{ISCKD_D} | D pin Setup/Hold with respect to CLK | 0.24/ -0.15 | 0.25/ -0.05 | 0.29/ -0.05 | 0.09/ -0.05 | ns |
| T _{ISDCK_DDLY} / T _{ISCKD_DDLY} | DDLY pin Setup/Hold with respect to CLK (using IODELAY2) | -0.25/ 0.30 | -0.25/ 0.42 | -0.25/ 0.56 | -0.54/ 0.67 | ns |
| T _{ISDCK_D_DDR} / T _{ISCKD_D_DDR} | D pin Setup/Hold with respect to CLK at DDR mode | -0.03/ 0.04 | -0.03/ 0.16 | -0.03/ 0.18 | -0.05/ 0.12 | ns |
| T _{ISDCK_DDLY_DDR} / T _{ISCKD_DDLY_DDR} | D pin Setup/Hold with respect to CLK at DDR mode (using IODELAY2) | -0.40/ 0.48 | -0.40/ 0.53 | -0.40/ 0.71 | -0.71/ 0.86 | ns |
| Sequential Delays | | | | | | |
| T _{ISCKO_Q} | CLKDIV to out at Q pin | 1.30 | 1.44 | 2.02 | 2.22 | ns |
| F _{CLKDIV} | CLKDIV maximum frequency | 270 | 262.5 | 250 | 125 | MHz |

Output Serializer/Deserializer Switching Characteristics

Table 38: OSERDES2 Switching Characteristics

| Symbol | Description | Speed Grade | | | | Units |
|--|---|----------------|----------------|----------------|----------------|-------|
| | | -3 | -3N | -2 | -1L | |
| Setup/Hold | | | | | | |
| T _{OSDCK_D} / T _{OSCKD_D} | D input Setup/Hold with respect to CLKDIV | -0.03/ 1.02 | -0.03/ 1.17 | -0.03/ 1.27 | -0.02/ 0.23 | ns |
| T _{OSDCK_T} / T _{OSCKD_T} ⁽¹⁾ | T input Setup/Hold with respect to CLK | -0.05/ 1.03 | -0.05/ 1.13 | -0.05/ 1.23 | -0.05/ 0.24 | ns |
| T _{OSCCK_OCE} / T _{OSCKC_OCE} | OCE input Setup/Hold with respect to CLK | 0.12/ -0.03 | 0.15/ -0.03 | 0.24/ -0.03 | 0.28/ -0.17 | ns |
| T _{OSCCK_TCE} / T _{OSCKC_TCE} | TCE input Setup/Hold with respect to CLK | 0.14/ -0.08 | 0.17/ -0.08 | 0.27/ -0.08 | 0.31/ -0.16 | ns |
| Sequential Delays | | | | | | |
| T _{OSCKO_OQ} | Clock to out from CLK to OQ | 0.94 | 1.11 | 1.51 | 1.89 | ns |
| T _{OSCKO_TQ} | Clock to out from CLK to TQ | 0.94 | 1.11 | 1.51 | 1.91 | ns |
| F _{CLKDIV} | CLKDIV maximum frequency | 270 | 262.5 | 250 | 125 | MHz |

Notes:

1. T_{OSDCK_T2} / T_{OSCKD_T2} (T input setup/hold with respect to CLKDIV) are reported as T_{OSDCK_T} / T_{OSCKD_T} in TRACE report.

Clock Buffers and Networks

Table 48: Global Clock Switching Characteristics (BUFGMUX)

| Symbol | Description | Devices | Speed Grade | | | | Units |
|--------------------------|-------------------------------|-------------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| T_{GSI} | S pin Setup to I0/I1 inputs | LX devices | 0.25 | 0.31 | 0.48 | 0.48 | ns |
| | | LXT devices | 0.25 | 0.31 | 0.48 | N/A | ns |
| T_{GIO} | BUFGMUX delay from I0/I1 to O | LX devices | 0.21 | 0.21 | 0.21 | 0.21 | ns |
| | | LXT devices | 0.21 | 0.21 | 0.21 | N/A | ns |
| Maximum Frequency | | | | | | | |
| F_{MAX} | Global clock tree (BUFGMUX) | LX devices | 400 | 400 | 375 | 250 | MHz |
| | | LXT devices | 400 | 400 | 375 | N/A | MHz |

Table 49: Input/Output Clock Switching Characteristics (BUFIO2)

| Symbol | Description | Devices | Speed Grade | | | | Units |
|--------------------------|--------------------------------|-------------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| T_{BUFCKO_O} | Clock to out delay from I to O | LX devices | 0.67 | 0.82 | 1.09 | 1.50 | ns |
| | | LXT devices | 0.67 | 0.82 | 1.09 | N/A | ns |
| Maximum Frequency | | | | | | | |
| F_{MAX} | I/O clock tree (BUFIO2) | LX devices | 540 | 525 | 500 | 300 | MHz |
| | | LXT devices | 540 | 525 | 500 | N/A | MHz |

Table 50: Input/Output Clock Switching Characteristics (BUFIO2FB)

| Symbol | Description | Devices | Speed Grade | | | | Units |
|--------------------------|---------------------------|-------------|-------------|------|-----|-----|-------|
| | | | -3 | -3N | -2 | -1L | |
| Maximum Frequency | | | | | | | |
| F_{MAX} | I/O clock tree (BUFIO2FB) | LX devices | 1080 | 1050 | 950 | 500 | MHz |
| | | LXT devices | 1080 | 1050 | 950 | N/A | MHz |

Table 51: Input/Output Clock Switching Characteristics (BUFPLL)

| Symbol | Description | Devices | Speed Grade | | | | Units |
|--------------------------|----------------------------|-------------|-------------|------|-----|-----|-------|
| | | | -3 | -3N | -2 | -1L | |
| Maximum Frequency | | | | | | | |
| F_{MAX} | BUFPLL clock tree (BUFPLL) | LX devices | 1080 | 1050 | 950 | 500 | MHz |
| | | LXT devices | 1080 | 1050 | 950 | N/A | MHz |

PLL Switching Characteristics

Table 52: PLL Specification

| Symbol | Description | Device(1) | Speed Grade | | | | Units |
|-------------|---|-------------|-------------|-----|-----|-----|-------|
| | | | -3 | -3N | -2 | -1L | |
| F_{INMAX} | Maximum Input Clock Frequency from I/O Clock | LX devices | 540 | 525 | 450 | 300 | MHz |
| | | LXT devices | 540 | 525 | 450 | N/A | MHz |
| | Maximum Input Clock Frequency from Global Clock | LX devices | 400 | 400 | 375 | 250 | MHz |
| | | LXT devices | 400 | 400 | 375 | N/A | MHz |

Table 56: Switching Characteristics for the Digital Frequency Synthesizer (DFS) for DCM_SP⁽¹⁾

| Symbol | Description | Speed Grade | | | | | | | | Units | |
|---|---|---------------------------------------|------|-----|------|-----|------|-----|------|-------|--|
| | | -3 | | -3N | | -2 | | -1L | | | |
| | | Min | Max | Min | Max | Min | Max | Min | Max | | |
| Output Frequency Ranges | | | | | | | | | | | |
| CLKOUT_FREQ_FX | Frequency for the CLKFX and CLKFX180 outputs | 5 | 375 | 5 | 375 | 5 | 333 | 5 | 200 | MHz | |
| Output Clock Jitter⁽²⁾⁽³⁾ | | | | | | | | | | | |
| CLKOUT_PER_JITT_FX | Period jitter at the CLKFX and CLKFX180 outputs. When CLKIN < 20 MHz | Use the Clocking Wizard | | | | | | | | ps | |
| | Period jitter at the CLKFX and CLKFX180 outputs. When CLKIN > 20 MHz | Typical = ±(1% of CLKFX period + 100) | | | | | | | | ps | |
| Duty Cycle⁽⁴⁾⁽⁵⁾ | | | | | | | | | | | |
| CLKOUT_DUTY_CYCLE_FX | Duty cycle precision for the CLKFX and CLKFX180 outputs including the BUFGMUX and clock tree duty-cycle distortion | Maximum = ±(1% of CLKFX period + 350) | | | | | | | | ps | |
| Phase Alignment⁽⁵⁾ | | | | | | | | | | | |
| CLKOUT_PHASE_FX | Phase offset between the DFS CLKFX output and the DLL CLK0 output when both the DFS and DLL are used | – | ±200 | – | ±200 | – | ±200 | – | ±250 | ps | |
| CLKOUT_PHASE_FX180 | Phase offset between the DFS CLKFX180 output and the DLL CLK0 output when both the DFS and DLL are used | Maximum = ±(1% of CLKFX period + 200) | | | | | | | | ps | |
| LOCKED Time | | | | | | | | | | | |
| LOCK_FX ⁽²⁾ | When FCLKIN < 50 MHz, the time from deassertion at the DCM's reset input to the rising transition at its LOCKED output. The DFS asserts LOCKED when the CLKFX and CLKFX180 signals are valid. When using both the DLL and the DFS, use the longer locking time. | – | 5 | – | 5 | – | 5 | – | 5 | ms | |
| | When FCLKIN > 50 MHz, the time from deassertion at the DCM's reset input to the rising transition at its LOCKED output. The DFS asserts LOCKED when the CLKFX and CLKFX180 signals are valid. When using both the DLL and the DFS, use the longer locking time. | – | 0.45 | – | 0.45 | – | 0.45 | – | 0.60 | ms | |

Notes:

- The values in this table are based on the operating conditions described in Table 2 and Table 55.
- For optimal jitter tolerance and a faster LOCK time, use the CLKIN_PERIOD attribute.
- Output jitter is characterized with no input jitter. Output jitter strongly depends on the environment, including the number of SSOs, the output drive strength, CLB utilization, CLB switching activities, switching frequency, power supply, and PCB design. The actual maximum output jitter depends on the system application.
- The CLKFX, CLKFXDV, and CLKFX180 outputs have a duty cycle of approximately 50%.
- Some duty cycle and alignment specifications include a percentage of the CLKFX output period. For example, this data sheet specifies a maximum CLKFX jitter of ±(1% of CLKFX period + 200 ps). Assuming that the CLKFX output frequency is 100 MHz, the equivalent CLKFX period is 10 ns, and 1% of 10 ns is 0.1 ns or 100 ps. Accordingly, the maximum jitter is ±(100 ps + 200 ps) = ±300 ps.

Table 59: Switching Characteristics for the Phase-Shift Clock in Variable Phase Mode⁽¹⁾

| Symbol | Description | Amount of Phase Shift | Units |
|-----------------------------|--|--|-------|
| Phase Shifting Range | | | |
| MAX_STEPS ⁽²⁾ | When CLKIN < 60 MHz, the maximum allowed number of DCM_DELAY_STEP steps for a given CLKIN clock period, where T = CLKIN clock period in ns. When using CLKIN_DIVIDE_BY_2 = TRUE, double the clock-effective clock period. | $\pm(\text{INTEGER}(10 \times (\text{CLKIN} - 3 \text{ ns})))$ | steps |
| | When CLKIN \geq 60 MHz, the maximum allowed number of DCM_DELAY_STEP steps for a given CLKIN clock period, where T = CLKIN clock period in ns. When using CLKIN_DIVIDE_BY_2 = TRUE, double the clock-effective clock period. | $\pm(\text{INTEGER}(15 \times (\text{CLKIN} - 3 \text{ ns})))$ | steps |
| FINE_SHIFT_RANGE_MIN | Minimum guaranteed delay for variable phase shifting. | $\pm(\text{MAX_STEPS} \times \text{DCM_DELAY_STEP_MIN})$ | ps |
| FINE_SHIFT_RANGE_MAX | Maximum guaranteed delay for variable phase shifting | $\pm(\text{MAX_STEPS} \times \text{DCM_DELAY_STEP_MAX})$ | ps |

Notes:

- The values in this table are based on the operating conditions described in Table 53 and Table 58.
- The maximum variable phase shift range, MAX_STEPS, is only valid when the DCM has no initial fixed-phase shifting, that is, the PHASE_SHIFT attribute is set to 0.
- The DCM_DELAY_STEP values are provided at the end of Table 54.

Table 60: Miscellaneous DCM Timing Parameters⁽¹⁾

| Symbol | Description | Min | Max | Units |
|----------------|---------------------------------------|-----|-----|--------------|
| DCM_RST_PW_MIN | Minimum duration of a RST pulse width | 3 | – | CLKIN cycles |

Notes:

- This limit only applies to applications that use the DCM DLL outputs (CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV). The DCM DFS outputs (CLKFX, CLKFXDV, CLKFX180) are unaffected.

Table 61: Frequency Synthesis

| Attribute | Min | Max |
|-----------------------------|-----|-----|
| CLKFX_MULTIPLY (DCM_SP) | 2 | 32 |
| CLKFX_DIVIDE (DCM_SP) | 1 | 32 |
| CLKDV_DIVIDE (DCM_SP) | 1.5 | 16 |
| CLKFX_MULTIPLY (DCM_CLKGEN) | 2 | 256 |
| CLKFX_DIVIDE (DCM_CLKGEN) | 1 | 256 |
| CLKFXDV_DIVIDE (DCM_CLKGEN) | 2 | 32 |

Table 62: DCM Switching Characteristics

| Symbol | Description | Speed Grade | | | | Units |
|--|------------------------|---------------|---------------|---------------|---------------|-------|
| | | -3 | -3N | -2 | -1L | |
| T _{DMCCK_PSEN} /T _{DMCKC_PSEN} | PSEN Setup/Hold | 1.50/ 0.00 | 1.50/ 0.00 | 1.50/ 0.00 | 1.50/ 0.00 | ns |
| T _{DMCCK_PSINCDEC} /T _{DMCKC_PSINCDEC} | PSINCDEC Setup/Hold | 1.50/ 0.00 | 1.50/ 0.00 | 1.50/ 0.00 | 1.50/ 0.00 | ns |
| T _{DMCKO_PSDONE} | Clock to out of PSDONE | 1.50 | 1.50 | 1.50 | 1.50 | ns |

Spartan-6 Device Pin-to-Pin Output Parameter Guidelines

All devices are 100% functionally tested. The representative values for typical pin locations and normal clock loading are listed in [Table 63](#) through [Table 69](#). Values are expressed in nanoseconds unless otherwise noted.

Table 63: Global Clock Input to Output Delay Without DCM or PLL

| Symbol | Description | Device | Speed Grade | | | | Units |
|---|--|------------|-------------|------|------|-------|-------|
| | | | -3 | -3N | -2 | -1L | |
| LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>without</i> DCM or PLL | | | | | | | |
| TICKOF | Global Clock and OUTFF <i>without</i> DCM or PLL | XC6SLX4 | 6.12 | N/A | 7.68 | 9.41 | ns |
| | | XC6SLX9 | 6.12 | 6.51 | 7.68 | 9.41 | ns |
| | | XC6SLX16 | 5.98 | 6.42 | 7.48 | 9.10 | ns |
| | | XC6SLX25 | 6.20 | 6.69 | 7.84 | 9.44 | ns |
| | | XC6SLX25T | 6.20 | 6.69 | 7.84 | N/A | ns |
| | | XC6SLX45 | 6.37 | 6.88 | 8.10 | 9.61 | ns |
| | | XC6SLX45T | 6.37 | 6.88 | 8.10 | N/A | ns |
| | | XC6SLX75 | 6.39 | 6.99 | 8.16 | 10.18 | ns |
| | | XC6SLX75T | 6.39 | 6.99 | 8.16 | N/A | ns |
| | | XC6SLX100 | 6.59 | 7.18 | 8.41 | 10.31 | ns |
| | | XC6SLX100T | 6.59 | 7.18 | 8.41 | N/A | ns |
| | | XC6SLX150 | 6.98 | 7.68 | 8.80 | 10.62 | ns |
| | | XC6SLX150T | 6.98 | 7.68 | 8.80 | N/A | ns |
| | | XA6SLX4 | 6.44 | N/A | 7.68 | N/A | ns |
| | | XA6SLX9 | 6.44 | N/A | 7.68 | N/A | ns |
| | | XA6SLX16 | 6.30 | N/A | 7.48 | N/A | ns |
| | | XA6SLX25 | 6.52 | N/A | 7.84 | N/A | ns |
| | | XA6SLX25T | 6.52 | N/A | 7.84 | N/A | ns |
| | | XA6SLX45 | 6.69 | N/A | 8.12 | N/A | ns |
| | | XA6SLX45T | 6.69 | N/A | 8.12 | N/A | ns |
| | | XA6SLX75 | 6.89 | N/A | 8.16 | N/A | ns |
| | | XA6SLX75T | 6.89 | N/A | 8.16 | N/A | ns |
| | | XA6SLX100 | N/A | N/A | 8.36 | N/A | ns |
| | | XQ6SLX75 | N/A | N/A | 8.16 | 10.18 | ns |
| | | XQ6SLX75T | 6.89 | N/A | 8.16 | N/A | ns |
| | | XQ6SLX150 | N/A | N/A | 8.80 | 10.62 | ns |
| | | XQ6SLX150T | 7.61 | N/A | 8.80 | N/A | ns |

Notes:

- Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.

Table 64: Global Clock Input to Output Delay With DCM in System-Synchronous Mode

| Symbol | Description | Device | Speed Grade | | | | Units |
|---|--|------------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>with</i> DCM in System-Synchronous Mode. | | | | | | | |
| TICKOFDCM | Global Clock and OUTFF <i>with</i> DCM | XC6SLX4 | 4.23 | N/A | 6.11 | 6.60 | ns |
| | | XC6SLX9 | 4.23 | 5.17 | 6.11 | 6.60 | ns |
| | | XC6SLX16 | 4.28 | 4.57 | 5.34 | 6.36 | ns |
| | | XC6SLX25 | 3.95 | 4.18 | 4.59 | 6.91 | ns |
| | | XC6SLX25T | 3.95 | 4.18 | 4.59 | N/A | ns |
| | | XC6SLX45 | 4.37 | 4.70 | 5.50 | 6.85 | ns |
| | | XC6SLX45T | 4.37 | 4.70 | 5.50 | N/A | ns |
| | | XC6SLX75 | 3.90 | 4.23 | 4.77 | 6.31 | ns |
| | | XC6SLX75T | 3.90 | 4.23 | 4.77 | N/A | ns |
| | | XC6SLX100 | 3.86 | 4.16 | 4.66 | 7.25 | ns |
| | | XC6SLX100T | 3.90 | 4.16 | 4.66 | N/A | ns |
| | | XC6SLX150 | 4.03 | 4.33 | 4.83 | 6.63 | ns |
| | | XC6SLX150T | 4.03 | 4.33 | 4.83 | N/A | ns |
| | | XA6SLX4 | 4.55 | N/A | 6.11 | N/A | ns |
| | | XA6SLX9 | 4.55 | N/A | 6.11 | N/A | ns |
| | | XA6SLX16 | 4.62 | N/A | 5.33 | N/A | ns |
| | | XA6SLX25 | 4.27 | N/A | 4.59 | N/A | ns |
| | | XA6SLX25T | 4.27 | N/A | 4.69 | N/A | ns |
| | | XA6SLX45 | 4.69 | N/A | 5.50 | N/A | ns |
| | | XA6SLX45T | 4.69 | N/A | 5.50 | N/A | ns |
| | | XA6SLX75 | 4.22 | N/A | 4.77 | N/A | ns |
| | | XA6SLX75T | 4.22 | N/A | 4.77 | N/A | ns |
| | | XA6SLX100 | N/A | N/A | 5.34 | N/A | ns |
| | | XQ6SLX75 | N/A | N/A | 4.77 | 6.31 | ns |
| | | XQ6SLX75T | 4.22 | N/A | 4.77 | N/A | ns |
| | | XQ6SLX150 | N/A | N/A | 4.96 | 6.63 | ns |
| | | XQ6SLX150T | 4.62 | N/A | 4.96 | N/A | ns |

Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. DCM output jitter is already included in the timing calculation.

Table 67: Global Clock Input to Output Delay With PLL in Source-Synchronous Mode

| Symbol | Description | Device | Speed Grade | | | | Units |
|---|--|------------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>with</i> PLL in Source-Synchronous Mode. | | | | | | | |
| T _{CLOCKPLL_0} | Global Clock and OUTFF <i>with</i> PLL | XC6SLX4 | 5.49 | N/A | 7.44 | 8.55 | ns |
| | | XC6SLX9 | 5.49 | 6.29 | 7.44 | 8.55 | ns |
| | | XC6SLX16 | 5.23 | 5.77 | 6.79 | 8.21 | ns |
| | | XC6SLX25 | 5.00 | 5.35 | 6.10 | 8.54 | ns |
| | | XC6SLX25T | 5.00 | 5.35 | 6.10 | N/A | ns |
| | | XC6SLX45 | 5.59 | 6.03 | 7.02 | 8.39 | ns |
| | | XC6SLX45T | 5.59 | 6.03 | 7.02 | N/A | ns |
| | | XC6SLX75 | 4.96 | 5.41 | 6.22 | 8.32 | ns |
| | | XC6SLX75T | 4.96 | 5.41 | 6.22 | N/A | ns |
| | | XC6SLX100 | 4.97 | 5.42 | 6.21 | 9.08 | ns |
| | | XC6SLX100T | 5.01 | 5.42 | 6.21 | N/A | ns |
| | | XC6SLX150 | 4.59 | 5.06 | 5.86 | 8.13 | ns |
| | | XC6SLX150T | 4.59 | 5.06 | 5.86 | N/A | ns |
| | | XA6SLX4 | 5.79 | N/A | 7.32 | N/A | ns |
| | | XA6SLX9 | 5.79 | N/A | 7.32 | N/A | ns |
| | | XA6SLX16 | 5.56 | N/A | 6.66 | N/A | ns |
| | | XA6SLX25 | 5.40 | N/A | 5.97 | N/A | ns |
| | | XA6SLX25T | 5.40 | N/A | 6.07 | N/A | ns |
| | | XA6SLX45 | 5.89 | N/A | 6.90 | N/A | ns |
| | | XA6SLX45T | 5.89 | N/A | 6.90 | N/A | ns |
| | | XA6SLX75 | 5.27 | N/A | 6.12 | N/A | ns |
| | | XA6SLX75T | 5.27 | N/A | 6.12 | N/A | ns |
| | | XA6SLX100 | N/A | N/A | 6.80 | N/A | ns |
| | | XQ6SLX75 | N/A | N/A | 6.12 | 8.32 | ns |
| | | XQ6SLX75T | 5.27 | N/A | 6.12 | N/A | ns |
| | | XQ6SLX150 | N/A | N/A | 5.88 | 8.13 | ns |
| | | XQ6SLX150T | 5.21 | N/A | 5.88 | N/A | ns |

Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. PLL output jitter is included in the timing calculation.

Table 75: Global Clock Setup and Hold With PLL in Source-Synchronous Mode

| Symbol | Description | Device | Speed Grade | | | | Units |
|---|--|------------|-------------|-----------|-----------|-----------|-------|
| | | | -3 | -3N | -2 | -1L | |
| Input Setup and Hold Time Relative to Global Clock Input Signal for LVCMOS25 Standard.⁽¹⁾ | | | | | | | |
| T _{PSPLL0} / T _{PHPPLL0} | No Delay Global Clock and IFF ⁽²⁾ with PLL in Source-Synchronous Mode | XC6SLX4 | 0.47/1.08 | N/A | 0.47/1.60 | 1.15/1.68 | ns |
| | | XC6SLX9 | 0.47/1.08 | 0.47/1.35 | 0.47/1.60 | 1.15/1.68 | ns |
| | | XC6SLX16 | 0.37/0.75 | 0.37/0.82 | 0.51/0.94 | 0.57/1.31 | ns |
| | | XC6SLX25 | 0.69/1.06 | 0.69/1.06 | 0.69/1.06 | 1.86/1.67 | ns |
| | | XC6SLX25T | 0.69/1.06 | 0.69/1.06 | 0.69/1.06 | N/A | ns |
| | | XC6SLX45 | 0.57/1.05 | 0.65/1.10 | 0.65/1.18 | 1.02/1.65 | ns |
| | | XC6SLX45T | 0.57/1.06 | 0.65/1.10 | 0.65/1.18 | N/A | ns |
| | | XC6SLX75 | 0.86/1.04 | 0.87/1.04 | 0.90/1.04 | 1.34/1.55 | ns |
| | | XC6SLX75T | 0.86/1.04 | 0.87/1.04 | 0.90/1.04 | N/A | ns |
| | | XC6SLX100 | 0.53/1.13 | 0.54/1.13 | 0.55/1.13 | 0.89/2.39 | ns |
| | | XC6SLX100T | 0.53/1.13 | 0.54/1.13 | 0.55/1.13 | N/A | ns |
| | | XC6SLX150 | 0.50/1.31 | 0.51/1.31 | 0.52/1.31 | 1.02/1.72 | ns |
| | | XC6SLX150T | 0.50/1.31 | 0.51/1.31 | 0.52/1.31 | N/A | ns |
| | | XA6SLX4 | 0.71/0.93 | N/A | 0.62/1.47 | N/A | ns |
| | | XA6SLX9 | 0.71/0.93 | N/A | 0.62/1.47 | N/A | ns |
| | | XA6SLX16 | 0.92/0.69 | N/A | 0.63/0.82 | N/A | ns |
| | | XA6SLX25 | 0.99/0.94 | N/A | 0.96/0.94 | N/A | ns |
| | | XA6SLX25T | 0.99/0.94 | N/A | 1.04/0.94 | N/A | ns |
| | | XA6SLX45 | 0.63/1.02 | N/A | 0.72/1.05 | N/A | ns |
| | | XA6SLX45T | 0.63/1.02 | N/A | 0.72/1.05 | N/A | ns |
| | | XA6SLX75 | 0.88/0.89 | N/A | 1.02/0.89 | N/A | ns |
| | | XA6SLX75T | 0.88/0.89 | N/A | 1.02/0.89 | N/A | ns |
| | | XA6SLX100 | N/A | N/A | 1.25/0.96 | N/A | ns |
| | | XQ6SLX75 | N/A | N/A | 1.02/0.89 | 1.34/1.55 | ns |
| | | XQ6SLX75T | 0.88/0.89 | N/A | 1.02/0.89 | N/A | ns |
| | | XQ6SLX150 | N/A | N/A | 0.63/1.19 | 1.02/1.72 | ns |
| | | XQ6SLX150T | 0.60/1.19 | N/A | 0.63/1.19 | N/A | ns |

Notes:

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage. These measurements include PLL CLKOUT0 jitter.
2. IFF = Input Flip-Flop or Latch
3. Use IBIS to determine any duty-cycle distortion incurred using various standards.

Source-Synchronous Switching Characteristics

The parameters in this section provide the necessary values for calculating timing budgets for Spartan-6 FPGA source-synchronous transmitter and receiver data-valid windows.

Table 78: Duty Cycle Distortion and Clock-Tree Skew

| Symbol | Description | Device ⁽¹⁾ | Speed Grade | | | | Units |
|-------------------|--|--------------------------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| T_{DCD_CLK} | Global Clock Tree Duty Cycle Distortion ⁽²⁾ | LX4 | 0.20 | N/A | 0.20 | 0.35 | ns |
| | | LX9 | 0.20 | 0.20 | 0.20 | 0.35 | ns |
| | | LX16 | 0.20 | 0.20 | 0.20 | 0.35 | ns |
| | | LX25 | 0.20 | 0.20 | 0.20 | 0.35 | ns |
| | | LX25T | 0.20 | 0.20 | 0.20 | N/A | ns |
| | | LX45 | 0.20 | 0.20 | 0.20 | 0.35 | ns |
| | | LX45T | 0.20 | 0.20 | 0.20 | N/A | ns |
| | | LX75 | 0.20 | 0.20 | 0.20 | 0.35 | ns |
| | | LX75T | 0.20 | 0.20 | 0.20 | N/A | ns |
| | | LX100 | 0.20 | 0.20 | 0.20 | 0.35 | ns |
| | | LX100T | 0.20 | 0.20 | 0.20 | N/A | ns |
| | | LX150 | 0.35 | 0.35 | 0.35 | 0.35 | ns |
| | | LX150T | 0.35 | 0.35 | 0.35 | N/A | ns |
| T_{CKSKEW} | Global Clock Tree Skew ⁽³⁾ | LX4 | 0.25 | N/A | 0.25 | 0.29 | ns |
| | | LX9 | 0.25 | 0.25 | 0.25 | 0.29 | ns |
| | | LX16 | 0.15 | 0.15 | 0.15 | 0.22 | ns |
| | | LX25 | 0.26 | 0.26 | 0.26 | 0.41 | ns |
| | | LX25T | 0.26 | 0.26 | 0.26 | N/A | ns |
| | | LX45 | 0.20 | 0.20 | 0.20 | 0.28 | ns |
| | | LX45T | 0.20 | 0.20 | 0.20 | N/A | ns |
| | | LX75 | 0.56 | 0.56 | 0.56 | 0.50 | ns |
| | | LX75T | 0.56 | 0.56 | 0.56 | N/A | ns |
| | | XC6SLX100 ⁽⁴⁾ | 0.22 | 0.22 | 0.22 | 0.21 | ns |
| | | XA6SLX100 ⁽⁴⁾ | N/A | N/A | 0.43 | N/A | ns |
| | | LX100T | 0.22 | 0.22 | 0.22 | N/A | ns |
| | | LX150 | 0.48 | 0.48 | 0.48 | 0.35 | ns |
| | | LX150T | 0.48 | 0.48 | 0.48 | N/A | ns |
| T_{DCD_BUFIO2} | I/O clock tree duty cycle distortion | LX devices | 0.25 | 0.25 | 0.25 | 0.50 | ns |
| | | LXT devices | 0.25 | 0.25 | 0.25 | N/A | ns |

Table 78: Duty Cycle Distortion and Clock-Tree Skew (Cont'd)

| Symbol | Description | Device ⁽¹⁾ | Speed Grade | | | | Units |
|-----------------|---|-----------------------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| $T_{BUFIOSKEW}$ | I/O clock tree skew across one clock region | LX4 | 0.06 | N/A | 0.06 | 0.07 | ns |
| | | LX9 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX16 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX25 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX25T | 0.06 | 0.06 | 0.06 | N/A | ns |
| | | LX45 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX45T | 0.06 | 0.06 | 0.06 | N/A | ns |
| | | LX75 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX75T | 0.06 | 0.06 | 0.06 | N/A | ns |
| | | LX100 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX100T | 0.06 | 0.06 | 0.06 | N/A | ns |
| | | LX150 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX150T | 0.06 | 0.06 | 0.06 | N/A | ns |

Notes:

1. LXT devices are not available with a -1L speed grade. The LX4 is not available in -3N speed grade.
2. These parameters represent the worst-case duty cycle distortion observable at the pins of the device using LVDS output buffers. For cases where other I/O standards are used, IBIS can be used to calculate any additional duty cycle distortion that might be caused by asymmetrical rise/fall times.
3. The T_{CKSKEW} value represents the worst-case clock-tree skew observable between sequential I/O elements. Significantly less clock-tree skew exists for I/O registers that are close to each other and fed by the same or adjacent clock-tree branches. Use the Xilinx FPGA Editor and Timing Analyzer tools to evaluate clock skew specific to your application.
4. The T_{CKSKEW} is 0.43 ns for the XA6SLX100 device using a -2 speed grade and 0.22 ns for the XC6SLX100 devices using the -2 speed grade.

Table 79: Package Skew

| Symbol | Description | Device | Package ⁽²⁾ | Value | Units |
|---------------|-----------------------------|--------|------------------------|-------|-------|
| $T_{PKGSKEW}$ | Package Skew ⁽¹⁾ | LX4 | TQG144 | N/A | ps |
| | | | CPG196 | 23 | ps |
| | | | CSG225 | 58 | ps |
| | | LX9 | TQG144 | N/A | ps |
| | | | CPG196 | 23 | ps |
| | | | CSG225 | 58 | ps |
| | | | FT(G)256 | 88 | ps |
| | | | CSG324 | 64 | ps |
| | | LX16 | CPG196 | 19 | ps |
| | | | CSG225 | 70 | ps |
| | | | FT(G)256 | 71 | ps |
| | | | CSG324 | 54 | ps |
| | | LX25 | FT(G)256 | 90 | ps |
| | | | CSG324 | 61 | ps |
| | | | FG(G)484 | 84 | ps |
| | | LX25T | CSG324 | 48 | ps |
| | | | FG(G)484 | 112 | ps |

Table 79: Package Skew (Cont'd)

| Symbol | Description | Device | Package ⁽²⁾ | Value | Units |
|---------------|-----------------------------|--------|------------------------|-------|-------|
| $T_{PKGSKEW}$ | Package Skew ⁽¹⁾ | LX45 | CSG324 | 70 | ps |
| | | | CS(G)484 | 99 | ps |
| | | | FG(G)484 | 109 | ps |
| | | | FG(G)676 | 138 | ps |
| | | LX45T | CSG324 | 75 | ps |
| | | | CS(G)484 | 100 | ps |
| | | | FG(G)484 | 95 | ps |
| | | LX75 | CS(G)484 | 101 | ps |
| | | | FG(G)484 | 107 | ps |
| | | | FG(G)676 | 161 | ps |
| | | LX75T | CS(G)484 | 107 | ps |
| | | | FG(G)484 | 110 | ps |
| | | | FG(G)676 | 134 | ps |
| | | LX100 | CS(G)484 | 95 | ps |
| | | | FG(G)484 | 155 | ps |
| | | | FG(G)676 | 144 | ps |
| | | LX100T | CS(G)484 | 88 | ps |
| | | | FG(G)484 | 111 | ps |
| | | | FG(G)676 | 147 | ps |
| | | | FG(G)900 | 134 | ps |
| | | LX150 | CS(G)484 | 84 | ps |
| | | | FG(G)484 | 103 | ps |
| | | | FG(G)676 | 115 | ps |
| | | | FG(G)900 | 121 | ps |
| | | LX150T | CS(G)484 | 83 | ps |
| | | | FG(G)484 | 88 | ps |
| | | | FG(G)676 | 141 | ps |
| | | | FG(G)900 | 120 | ps |

Notes:

- These values represent the worst-case skew between any two SelectIO resources in the package: shortest delay to longest delay from Pad to Ball.
- Some of the devices are available in both Pb and Pb-free (additional G) packages as standard ordering options. See [DS160: Spartan-6 Family Overview](#) for more information.

Table 80: Sample Window

| Symbol | Description | Device ⁽¹⁾ | Speed Grade | | | | Units |
|--------------------|---|-----------------------|-------------|-----|-----|-----|-------|
| | | | -3 | -3N | -2 | -1L | |
| T_{SAMP} | Sampling Error at Receiver Pins ⁽²⁾ | All | 510 | 510 | 530 | 740 | ps |
| T_{SAMP_BUFI02} | Sampling Error at Receiver Pins using BUFI02 ⁽³⁾ | All | 430 | 430 | 450 | 590 | ps |

Notes:

- LXT devices are not available with a -1L speed grade.
- This parameter indicates the total sampling error of Spartan-6 FPGA DDR input registers, measured across voltage, temperature, and process. The characterization methodology uses the DCM to capture the DDR input registers' edges of operation. These measurements include:
 - CLK0 DCM jitter
 - DCM accuracy (phase offset)
 - DCM phase shift resolution
 These measurements do not include package or clock tree skew.
- This parameter indicates the total sampling error of Spartan-6 FPGA DDR input registers, measured across voltage, temperature, and process. The characterization methodology uses the BUFI02 clock network and IODELAY2 to capture the DDR input registers' edges of operation. These measurements do not include package or clock tree skew.

Table 81: Source-Synchronous Pin-to-Pin Setup/Hold and Clock-to-Out Using BUFI02 (Cont'd)

| Symbol | Description | Device | Speed Grade | | | | Units |
|---|-------------------------------------|------------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| Pin-to-Pin Clock-to-Out Using BUFI02 | | | | | | | |
| TICKOFCs | OFF clock-to-out using BUFI02 clock | XC6SLX4 | 5.51 | N/A | 6.95 | 8.45 | ns |
| | | XC6SLX9 | 5.51 | 5.89 | 6.95 | 8.45 | ns |
| | | XC6SLX16 | 5.31 | 5.70 | 6.67 | 8.21 | ns |
| | | XC6SLX25 | 5.53 | 6.00 | 7.02 | 8.72 | ns |
| | | XC6SLX25T | 5.53 | 6.00 | 7.02 | N/A | ns |
| | | XC6SLX45 | 5.76 | 6.18 | 7.22 | 8.77 | ns |
| | | XC6SLX45T | 5.76 | 6.18 | 7.22 | N/A | ns |
| | | XC6SLX75 | 5.94 | 6.46 | 7.57 | 9.72 | ns |
| | | XC6SLX75T | 5.94 | 6.46 | 7.57 | N/A | ns |
| | | XC6SLX100 | 6.09 | 6.53 | 7.60 | 9.66 | ns |
| | | XC6SLX100T | 6.09 | 6.53 | 7.60 | N/A | ns |
| | | XC6SLX150 | 6.29 | 6.69 | 7.81 | 9.94 | ns |
| | | XC6SLX150T | 6.29 | 6.69 | 7.81 | N/A | ns |
| | | XA6SLX4 | 5.83 | N/A | 6.95 | N/A | ns |
| | | XA6SLX9 | 5.83 | N/A | 6.95 | N/A | ns |
| | | XA6SLX16 | 5.65 | N/A | 6.68 | N/A | ns |
| | | XA6SLX25 | 5.85 | N/A | 7.03 | N/A | ns |
| | | XA6SLX25T | 5.85 | N/A | 7.03 | N/A | ns |
| | | XA6SLX45 | 6.07 | N/A | 7.25 | N/A | ns |
| | | XA6SLX45T | 6.07 | N/A | 7.25 | N/A | ns |
| | | XA6SLX75 | 6.26 | N/A | 7.57 | N/A | ns |
| | | XA6SLX75T | 6.26 | N/A | 7.57 | N/A | ns |
| | | XA6SLX100 | N/A | N/A | 7.48 | N/A | ns |
| | | XQ6SLX75 | N/A | N/A | 7.57 | 9.72 | ns |
| | | XQ6SLX75T | 6.26 | N/A | 7.57 | N/A | ns |
| | | XQ6SLX150 | N/A | N/A | 7.81 | 9.94 | ns |
| | | XQ6SLX150T | 6.62 | N/A | 7.81 | N/A | ns |

Revision History

The following table shows the revision history for this document.

| Date | Version | Description of Revisions |
|----------|---------|---|
| 06/24/09 | 1.0 | Initial Xilinx release. |
| 08/26/09 | 1.1 | Added V_{FS} to Table 1 and Table 2 . Added R_{FUSE} to Table 2 . Added XC6SLX75 and XC6SLX75T to V_{BATT} and I_{BATT} in Table 1 , Table 2 , and Table 4 . Corrected the quiescent supply current for the XC6SLX4 in Table 5 . Updated Table 11 . Removed DV_{PPIN} from Figure 2 . Removed $F_{PCIECORE}$ from Table 24 and added values to $F_{PCIEUSER}$. Added more networking applications to Table 25 . Updated values for $T_{SUSPENDLOW_AWAKE}$, $T_{SUSPEND_ENABLE}$, and T_{SCP_AWAKE} in Table 46 . Numerous changes to Table 47, page 54 including the addition of new values to various specifications, revising the $T_{SMCKCSO}$ description, and changing the units of T_{POR} . Also, removed <i>Dynamic Reconfiguration Port (DRP) for DCM and PLL Before and After DCLK section</i> from Table 47 and updated all the notes. In Table 52 , added to F_{INMAX} , revised F_{OUTMAX} , and removed PLL Maximum Output Frequency for BUFI02. Revised values for DCM_DELAY_STEP in Table 54 . Updated CLKIN_FREQ_FX values in Table 55 . |
| 01/04/10 | 1.2 | Added -4 speed grade to entire document. Updated speed specification of -4, -3, -2 speed grades to version 1.03. Added -1L speed grade numbers per speed specification 1.00. Updated T_{SOL} in Table 1 . Added -1L rows for LVCMOS12, LVCMOS15, and LVCMOS18 in Table 9 . Revised much of the detail in GTP Transceiver Specifications in Table 12 through Table 23 . Added -2 data to Table 25 . Updated F_{MAX} in Table 44 . Updated descriptions for $T_{DNACLKL}$ and $T_{DNACLKH}$ in Table 45 and revised values for all parameters. Removed $T_{INITADDR}$ from Table 47 and added new data. Updated values in Table 48 through Table 62 . Added Table 51 (BUFPLL) and Table 57 (DCM_CLKGEN). Removed $T_{LOCKMAX}$ note from Table 52 . Updated note 3 in Table 53 . In Table 79 : removed XC6SLX75CSG324 and XC6SLX75TCG324; added XC6SLX75FG(G)484 and XC6SLX75FG(G)484. |
| 02/22/10 | 1.3 | Production release of XC6SLX16 -2 speed grade devices. The changes to Table 26 and Table 27 includes updating this data sheet to the data in ISE v11.5 software with speed specification v1.06. Updated maximum of V_{IN} and V_{TS} and note 2 in Table 1 . In Table 2 , changed V_{IN} , added I_{IN} and note 5, revised notes 1, 6, and 7, and added note 8 to R_{FUSE} . In Table 4 , removed previous note 1 and added data to I_{RPU} , I_{RPD} , and I_{BATT} ; changed C_{IN} , added R_{DT} and R_{IN_TERM} , and added note 2 and 3. Updated V_{CCO2} in Table 6 . Added Table 7 and Table 8 . Removed PCI66_3 from Table 9 . Updated PCI33_3 and I2C in Table 9 . Updated the description of Table 11 . Completely updated Table 25 . Updated Table 28 including adding values for PCI33_3. Updated V_{REF} value for HSTL_III_18 in Table 31 . Updates missing V_{REF} values in Table 32 . Added Simultaneously Switching Outputs, page 36 . Removed T_{GSRQ} and T_{RPW} from Table 35 and Table 36 . Also removed T_{DOQ} from Table 36 . Removed T_{ISPO_DO} and note 1 from Table 37 . Removed T_{OSCCK_S} and combinatorial section from Table 38 . In Table 39 , removed T_{IODDO_T} and added new tap parameters and note 2. In Table 40 , Table 41 , and Table 42 , made typographical edits and removed notes. Removed clock CLK section in Table 41 . Removed clock CLK section and T_{REG_MUX} and T_{REG_M31} in Table 42 . Added block RAM F_{MAX} values to Table 43 . Updated values and added note 2 to Table 45 . Added values to Table 46 and removed note 1. Numerous changes to Table 47 . Completely updated Table 57 . Revised data in Table 62 . Removed note 3 from Table 71 . Added values to Table 79 . Added data to Table 80 and Table 81 . |
| 03/10/10 | 1.4 | Production release of XC6SLX45 -2 speed grade devices, which includes changes to Table 26 and Table 27 updating this data sheet to the data in ISE v11.5 software with speed specification v1.07. Fixed R_{IN_TERM} description in Table 4 . Added PCI66_3 to Table 7 and replaced note 1. Corrected note 1 and the V _{Max} for TMDS_33 in Table 8 . In Table 10 , added note 1 to LVPECL_33 and TMDS_33. Also updated specifications for TMDS_33. Updated the GTP Transceiver Specifications section including adding values to Table 16 , Table 17 , and Table 20 through Table 23 . Added PCI66_3 back into Table 9 , Table 28 , Table 31 , Table 32 , and Table 34 . Updated note 3 on Table 32 . In Table 34 , corrected some typographical errors and fixed SSO limits for bank1/3 in FG(G)484 package. Corrected $T_{OSCCK_OC_E}$ in Table 38 . In Table 57 , updated CLKFX_FREEZE_VAR and CLKFX_FREEZE_TEMP_SLOPE and added typical values to $T_{CENTER_LOW_SPREAD}$ and $T_{CENTER_HIGH_SPREAD}$. Updated and added values to Table 63 through Table 78 , and Table 81 . In Table 79 , revised the XC6SLX16-CSG324 and the XC6SLX45-CSG484 and FG(G)484 values. |